Multi-cores for Signal Processing

*Using Instruction Set Simulation to explore performance of LTE (Long Term Evolution) applications*

Master of Science Thesis in the Program “Networks and Distributed Systems”

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Göteborg, Sweden, November 2009
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Multi-cores for Signal Processing
Using instruction level simulation to explore performance of LTE applications

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Department of Computer Science and Engineering
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Abbreviations

4G  Fourth Generation
DSP  Digital Signal Processor
HDTV  High-definition television
HSPA  High Speed Packet Access
IP  Internet Protocol
ISS  Instruction Set Simulation
LTE  Long Term Evolution
MIMO  Multiple Input Multiple Output
OFDM  Orthogonal Frequency Division Multiplexing
PAPR  Peak to Average Power Ratio
QAM  Quadrature Amplitude Modulation
RAM  Random Access Memory
ROM  Read Only Memory
SAE  System Architecture Evolution
SC-FDMA  Single Carrier Frequency Division Multiple Access
SOC  System on Chip
TI  Texas Instruments
VSD  Virtualized Software Development
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Abstract

Increasing multimedia demands and mobile broadband has forced the cellular operators to adapt radio technologies that meet requirements of next generation (mobile TV, real time audio/video etc.). LTE (Long Term Evolution) is the radio technology that already meets most of 4G (Fourth generation) requirements. But to exploit higher data rates offered by LTE, powerful processing engines are required at mobile base stations. Multi-cores due to low power consumption and high performance are considered a natural choice however novelty of multi-cores combined with evolving LTE application software has forced the developers to use Instruction Set Simulators, which allows testing the application software on hardware that does not exist or is in short supply. Simics is one such simulation technology with special multi-core development tools, capable of simulating dozens of cores at adequate levels of speed and accuracy. An existing single core Simics model of the target hardware is modified and a 14 core hardware model is created, to accommodate the parallelized (14 part) LTE application. Simics helped in constructing the target multi-core hardware with relative ease, which consequently enabled the development of application software for it.
1 Introduction

1.1 Background
The ever increasing multimedia demands and the advent of mobile broadband has put the cellular operators under pressure to increase capacity and speed of their mobile phone networks. 4G is here. 4G demands an all IP packet switched network with data rates of at least 100 Mbps for downlink and high quality services for next generation multimedia (real time audio/video, high speed data, HDTV video content, mobile TV, etc) [1]. LTE (Long Term Evolution) is the radio technology and current state of the art [3] that meets most of these requirements. With high peak rates and low latency, LTE is ideal solution for mobile broadband which contributes 80% of the broadband market. Broadband subscriptions are projected to reach 3.4 billion in 2014 [2] and in this regard LTE is the front runner to make it a reality.

1.2 Problem
However to harness higher data rates offered by Long Term Evolution and to accommodate its complexity (features like MIMO technology, flexible bandwidth, complex modulations schemes, etc) powerful, novel and flexible processing engines are required at base stations. Just increasing the clock rate is no more a solution because of high power consumption. Therefore at this point in time, multi-cores operating at lower clock rates seem to be the only solution meeting primary goals of the cellular base stations, that is, less power consumption and high throughput. Now such high bandwidth management in real time demands hardware that perfectly couples the Long Term Evolution application. In the wake of evolution and changing requirements of the application it is almost impossible to select or build the target hardware before the application is ready. At the same time relative novelty of multi-cores makes it even more challenging. Under such circumstances when target hardware does not physically exist, Virtualized Software Development (VSD) is the solution.

1.3 Solution
Simics [6] is chosen as the development tool since it’s a full system simulator and is capable of virtualized co-development of software and hardware. Simics is an instruction level simulator and it can simulate multiple cores and chips at sufficient levels of accuracy and speed. It offers tools and support to manipulate simulation data statically as well as dynamically, e.g. Python control functions may be used for profiling purposes [4] to extract information out of the simulated system at run time. As a performance measure, the information could be number of executed cycles for a particular section of code. It also supports reverse execution which is extremely helpful for debugging purposes and critical for fast application development along with hardware. Using Simics, I have created a multi-core (14 core) Simics model of TI’s [5] DSK6455 single core (C64x+) DSP board and ported the LTE application software on it. The given LTE application has four main parts so first of all I created a 4 core model and assigned one part to each of its cores to make it a standalone DSP solution. As a next step, I identified the parts of application that can be done in parallel and divided the application into 14 parts. Now I created a 14 core model of DSK6455 board and ported the 14 part application on it.

1.4 Results
The focus of this study is to comprehend the potential of Virtualized System Development (Instruction Set Simulation) for multi-core DSPs. The creation of a 4 core target hardware that does not exist and running the complete four stage LTE application on it was the first major
step highlighting the worth of Virtualized Software development. The second important insight was how the software application has influenced the design of the target hardware. Initial plan was to make 16 core hardware but the construction of the application dictated that a 14 core model will utilize the resources optimally. Similarly it can not be ruled out that based on hardware limitations, for overall system enhancement, changes in the application software can also be suggested. So according to requirements VSD leverages modification in both hardware and software on the fly and consequently can identify major design flaws which otherwise could cost much more if found later on in the development cycle. Also multi-core programming, in case of general purpose multi-cores is very difficult however experiments reveal (14 core model reduces the latency more than 3 fold as compared to 4 core model) that LTE signal processing application is inherently parallel in nature therefore it can greatly benefit from multi-core architectures and dramatic increase in throughput (number of users) may be achieved with lesser hardware and minimal power consumption.

1.5 Outline
In the rest of the report first of all I will briefly explain LTE application requirements and its streaming behavior. Third part gives an overview of multi-cores and currently available commercial multi-core DSPs. Fourth part explains concept of Instruction set simulation and Simics as a Virtualized Software Development tool. Fifth chapter give details of Simics model building process and focuses on areas related to this thesis work, it also explains modeling procedure of 14 core DSK6455 DSP model. Sixth part explains how functional parallelism was identified in the application and how it was parallelized and possibility of using the same method in the future for lets say 100 cores DSP model. In seventh part experimental results are discussed. Eighth part concludes the whole thesis and the last part is about future work.
2 Intro to LTE

2.1 Background

LTE is considered to be the first step towards 4G. 4G actually defines a standard set of requirements to meet future demands of mobile phone networks. Primarily these requirements are set in response to current trends in the cellular industry. For example packet data traffic has surpassed voice traffic since summer of 2007 (see Figure 1) and since last two years there is exponential growth in data traffic as compared to voice traffic. This was mainly due to the introduction of HSPA which improved the end user experience. It increased the downlink speed up to 14 Mbps and uplink speed up to 5.4 Mbps and this increased bandwidth enabled the users to surf the web efficiently as well as in a limited way to enjoy real time contents like online audio and video and other multimedia services.

The other major indicator reflecting the increased demand of packet data is mobile broadband. Broadband subscriptions are projected to reach 3.4 billion in 2014 and 80% of it will be mobile broadband (see Figure 3). Anticipating these trends, 4G working group put forth objectives for new generation (4G) of mobile networks. The requirements related to bandwidth included high network capacity, spectral efficiency, data rate of 100 Mbps for a moving client and 1 Gbps for a static one and lower latency. LTE even in its current form happen to meet most of these requirements and even surpass a few as well.

2.2 Standardization

The first step towards LTE standardization was taken in Toronto, Canada in 2004 at 3GPP RAN Evolution workshop. The basic idea was to develop a framework for the progress of 3GPP radio network technology that could facilitate cheap cost per bit, adaptation of new and existing frequency bands, a simple architecture that could allow seamless integration with existing standards and which could enable mobile terminals to consume less power.
Current version of LTE represents improvements in Universal Mobile Telecommunications System (UMTS) which will be introduced in 3rd Generation Partnership Project (3GPP) Release 8 [7].

The original LTE requirements envisioned by 3GPP included

- 100 Mbps downlink and 50 Mbps uplink
- Reduce the Radio Access Network (RAN) time to less than 10 milliseconds (roundtrip time for complete LTE frame).
- Improved spectral efficiency as compared to HSPA release 6

Also LTE should be able to incorporate IP connectivity with improved broadcasting and flexible bandwidth allocation schemes. It should also support internetworking with existing 3G and networks not compliant with 3GPP standard.

The specification work for LTE completed in March 2009 (see Figure 2) and it is ensured that implementation based on 2009 specifications will meet backward compatibility.

### 2.3 Architecture and Technicalities

In the network world there was a constant effort to develop a common standard protocol which could serve as middleware for various existing network protocols. The introduction and success of internet has made packet based IP protocol as the universal standard. Realizing this 3GPP in 2004 proposed IP as the protocol for next generation of its networks. This recommendation of a new architecture is a part of the 3GPP System Architecture Evolution (SAE). LTE-SAE is designed to incorporate and support huge market share of IP-based services.

LTE uses OFDM (Orthogonal frequency division multiplexing) for both uplink and downlink. OFDM is chosen as the radio technology because it meets the LTE requirements for spectrum flexibility and wide carriers for peak data rates. However the standard version of OFDM has high Peak to Average Power Ratio (PAPR). Which means that in order to manage PAPR in the mobile terminal, you have to use expensive power amplifiers that would increase cost of the terminal and also would drains its battery faster. Therefore uplink uses a pre-coded version of OFDM called SC-FDMA which addresses these issues.

To achieve peak data rates and extended coverage that meets the future broadband requirements another enhancement that LTE borrows from HSPA is advanced antenna solutions. There are different variants of it based on the arising situation. For example extended coverage is supported using beam forming and peak data rates are achieved using MIMO technology that employs multiple input and output antennas.
3 Overview of Multi-cores

3.1 Background
In recent past, for almost a decade, the most popular approach to gain computational performance was to increase the clock rate or to devise new strategies for exploiting ILP (instruction level parallelism). As a result every new enhancement to get more ILP made the architecture more complex, consuming much more power. Both these approaches have exhausted because of diminishing returns and issues of high power consumption and dissipation.

Now the fact that clock rate can not be increased beyond a certain limit due to power dissipation (see Figure 4), the only way forward, one may imagine at this point in time, is to increase the number of cores and hope that software, which is predominantly sequential in nature, will be parallelized to take advantage of this increased performance, offered by these multiple cores on chip.

Parallelism promises same or higher performance at lower clock rates (as work can be done in parallel). Lower clock rate means lesser power consumption.

3.2 Multi-cores and signal processing (LTE application)
Fortunately, most of the signal-processing applications are parallel in nature (signal processing applications are extensively SIMD (Single Instruction Multiple Data) because it deals most of the time with matrix and vector data which may be processed independently), this factor also tempts to yearn for parallelism at coarse grained (thread) level rather than instruction level. Therefore signal processing applications can immensely benefit from multi-core architectures.

It is argued that the design of multi-cores for such applications should be simpler (due to predictable execution loops there will be less complicated issues of cache coherence, dynamic prediction and synchronization etc) as compared to general purpose multi-cores and this fact is verified during this thesis work as well. For example in the process of parallelizing the LTE application code to make it run on 14 cores, I was able to identify parts of the application, that could be done in parallel, by simply inspecting the code.

3.3 Why Texas Instrument®?
The selection of TI® as the DSP vendor for this thesis work is done after performing various case studies on existing multi-core DSPs commercially available in the market. There are lots
of factors contributing to the worth of a multi-core DSP however we selected and focused our attention on areas that are potentially critical for the existence of any DSP solution in the foreseeable future. These include scalability, software model, development support, multi-threading and power consumption.

After much consideration, TI’s solution is selected primarily because it’s famous TMS320C64x+™ DSP core is available for experimentation in virtual form. Virtutech® [6] has developed its virtual model in Simics™ [6]. This model has good signal processing capabilities and is available to academia for experimentation. This virtualized model has opened a whole new range of possibilities for software developers. Simics will be explained, in detail, in the following chapters.

The major DSPs studied are Freescale™ semiconductor MSC8156, TILERA® TILEPro64 and Texas Instruments® TMS320C6455. I will now briefly discuss architecture of TI’s DSPs in terms of their future scalability and will also touch upon Freescale® and TILERA® DSPs. Some of the salient features of these DSPs may be found in Table 1.

3.4 Texas Instruments

This thesis work is based on Texas Instruments® TMS320C6455 DSP. The actual case study was done for TI’s latest commercial DSP, TMS320TCI6487. However these devices are very similar. The most important factor is that both these DSPs use the famous TMS320C64x+™ CPU core for which Virtutech® has developed the virtualized processor. Also both these DSPs have same mix of peripherals and on chip memories. The main difference is that TCI6487 has three C64x+™ DSP cores (c6455 has one), a faster DDR2 memory and new antenna support. Nonetheless for the purpose of this thesis work, architecturally both these DSPs are the same.

First I will briefly explain the architecture of TMS320C6455 DSP and C64x+™ CPU core, after that will discuss the findings about TMS320TCI6487 DSP.

3.4.1 TMS320C6455

This DSP is based on advanced VelociTI™, very-long-instruction-word (VLIW) architecture developed by TI®, targeting video, telecom and Wireless infrastructures. It has performance of 9600 MIPS (million instructions per second) operating at a clock rate of 1.2 GHz and 90nm process technology is used in fabrication. Power dissipation is 3.3W and performance per Watt is 2.9 MIPS/mW.

TMS320C6455 device has 2Mbyte L2 memory and 32 Kbyte level1 program (L1P) and data (L1D) memories (see Figure 5). L1D is two way set associative cache where is L1P is direct mapped. L2 memory may be used as 4-way set associative cache or configured as SRAM.

3.4.2 C64x+ CPU core

C64x+ CPU comprises of eight functional units, two register files and two data paths (see Figure 6). Since
signal processing applications are math intensive therefore C64x+ incorporates special instruction set enhancements for multiplication and arithmetic logic operations like 32bit multiply, complex multiplication and parallel add and subtract.

3.4.3 TMS320TCI6487
TCI6487 is one of TI’s latest commercial DSP specifically targeting wireless infrastructure applications. Therefore I have looked at its multi-core architecture critically.

3.4.4 TCI6487 Case study

Operating System
There is no sophisticated operating system present (like Linux® kernel 2.6) which may leverage multiple concurrent task management (using scheduling techniques like priority scheduling, time sliced scheduling etc). However it supports DSP/BIOS, a RTOS (Real Time Operating System) but this RTOS has limitations e.g. it supports only priority scheduling based on software interrupts and tasks, which means that some low priority tasks might starve and there could be “priority inversion” issues. The advantage of an RTOS is that DSP/BIOS allows direct access to manipulate hardware resources (which is not possible to that extent in Linux since it maintains strict separation between user application and physical resources, so if a user space program accesses a device an expensive context switch to kernel mode is required) e.g. hardware interrupts which gives more fine grained control to reduce system latency. To address these issues related to both GPOS(General purpose OS) and RTOS a third party supplier Virtual Logix® has tried to come up with a hybrid solution, namely VLX (a virtualizer), enabling a Linux based development environment to run alongside TI’s DSP/BIOS.

Architecture and Scalability

Coherency
There is no cache coherence protocol implementation (snoopy, directory based etc) between on chip caches and memory, among the three cores. However for a multi-core solution to work correctly, shared memory transactions (reads, writes) should meet serializability and sequential consistency conditions. TCI6487 uses the semaphores module to meet these conditions[16]. Not only it manages resource sharing but also helps in keeping cache coherency between the three cores. A multi-core shared memory semaphore implementation (for cache coherency) requires two main ingredients, one, hardware should support atomic read-modify-write operations (e.g. test and set, test test and set etc) and, two, these operations should be non interruptible (similar to single processor implementation to maintain sequential consistency). But this two fold semaphore solution comes at a price, e.g. a resource (e.g. SRIOTM) can not be shared between two cores at the same time, one has to wait for the resource until it receives the signal from the other (core) to go ahead.

Architecture scalability
Literally three C64x+ cores are placed side by side on one chip. One reason could be that multi-cores in embedded industry are still at an early stage. But in the wake of dozens, if not hundreds, of cores on chip in the near future, an operating system similar to Linux is dearly required which could support multithreading, manage load balancing, load sharing and switch off idle chips etc. However currently according to TI [13], they have intentionally kept it generic so that third parties could come up with innovative ideas and solutions.
Expensive (in terms of CPU cycle consumption) semaphore signaling means there will be issues related to synchronization and latency because of resources blocking. Also I think this approach is not scalable from futuristic point of view as well, even by adding a few more cores, the complexity of its architecture will greatly increase. However current DSP solutions has cores in single digit and there are no critical issues of load balancing or scheduling. This is partly due to extensive SIMD nature of signal processing applications.

With a weakness in multi-cores, TI is focusing more on functional integration, that is, defining TCI6487 scalability in terms of number of chips that can be connected together seamlessly using for example SRIO daisy chain network which uses hardware packet forwarding to advance data to a specific DSP in the daisy chain, however message passing is always expensive and a serious performance bottleneck. Based on requirements they have proposed a so called system-on-chip architecture if there is no task dependency among chips and each DSP is doing the same functions and other architecture called customized architecture if role of each DSP is different from each other.

3.5 TILERA
TILERA’s TILEPro64™ processor targets the embedded market. It has an impressive 64 processor cores connected to each other through its iMesh™ network. Each processor has L1 and L2 cache and a non blocking connection to the iMesh™. It incorporates its trade mark dynamic distributed cache (employs concept of “neighborhood caching”, so in case of miss a processor may consult remote processor’s sub-cache) which claims to be twice as fast compared to other multi-cores. Also each processor tile can run independent operating system or multiple tiles may be combined together to form SMP Linux like OS. Each processor support 32bit VLIW architecture and is capable of handling up to 3 instructions per cycle.

3.6 Freescale semiconductor
The latest Freescale DSPs aimed at wireless base stations is MSC8156, it has 6 cores (StarCore SC3850) operating at 1GHz, a built in Multi Accelerator Platform Engine for Baseband (MAPLE-B) and various other features to optimize it for 3G-LTE, 3GPP, TD-SCDMA etc. It’s an enhanced version of previous chip combo of MSC8144/MSBA8100 that Freescale® launched in the middle of 2008. MSC8144 is a quad core (SC3400) DSP chip that works with MSBA8100 chip which is a baseband accelerator. It has 32 Kbyte L1 instruction and data cache available on each core. Also it includes 512 Kbyte L2 cache which may be used for both instruction and data along with 1056 Kbyte shared M3.
Table 1: DSP comparisons

<table>
<thead>
<tr>
<th>Vendor</th>
<th>DSP</th>
<th># of Cores / Frequency</th>
<th>Power</th>
<th>CMO S Tech.</th>
<th>Language support</th>
<th>System Simulator</th>
</tr>
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<tbody>
<tr>
<td>Freescale®</td>
<td>MSC8156</td>
<td>6 / 1GHz</td>
<td>10 W</td>
<td>45 nm</td>
<td>C, C++ compiler</td>
<td>yes</td>
</tr>
<tr>
<td>TI®</td>
<td>TMS320T Cl6487</td>
<td>3 / 1GHz</td>
<td>6 W</td>
<td>65 nm</td>
<td>C, C++ compiler</td>
<td>N/A</td>
</tr>
<tr>
<td>TILERA®</td>
<td></td>
<td>64 / 866 MHz</td>
<td>23 W</td>
<td>65 nm</td>
<td>C, C++ compiler</td>
<td>yes</td>
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<th>Vendor</th>
<th>DSP</th>
<th>Throughput</th>
<th>Development tool</th>
<th>Operating System Support</th>
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<tr>
<td>Freescale®</td>
<td>MSC8156</td>
<td>48000 MMACS</td>
<td>CodeWarrior v10</td>
<td>SmartDSP</td>
</tr>
<tr>
<td>TI®</td>
<td>TMS320T Cl6487</td>
<td>24,800 MMACS (16-bit)</td>
<td>Code Composer Studio</td>
<td>DSP/BIOS</td>
</tr>
<tr>
<td>TILERA®</td>
<td>TILEPro64</td>
<td>Max. of 443 billion operations per second</td>
<td>MDE</td>
<td>SMP Linux with 2.6 kernel</td>
</tr>
</tbody>
</table>
4 Instruction Set Simulation

4.1 Background
Simulations are used to recreate an environment for the real system in enough detail, so that the desired effects can be observed [8]. Simulators therefore eliminate the need of actual hardware unavailability or shortage, which is most of the time a major bottleneck for software developers.

4.1.1 Why Instruction set Simulators?
When one talks about simulators the next obvious question is do you need an accurate simulation or exact numbers? Or you need fast simulation speed for functional verification of your software application? Before answering these questions lets see how simulators actually work.

There are two broad categories of simulators

1) Timing/cycle accurate simulators
2) Instruction set simulators

4.1.2 Timing Accurate simulators
Timing accurate simulators works in cycle (timing) accuracy and provides very high visibility into processor and applications. In this mode, in order to model detailed operations like bit reset and register access etc. a lot of computation power is required therefore this mode is very slow and running of only core algorithms in this mode are recommended.

4.1.3 Instruction set simulators (ISS)
Instruction set simulators simulates the target processor at instruction set level. These simulators are detailed enough to run the executable programs written for the intended target machine.

Advantages
The biggest advantage of instruction set simulators is that they can be used to execute applications for computers that, for various reasons, do not exist. Another major advantage is that they can be used to view the internal state of the system which in case of real hardware is not possible. Also with the introduction of multi-cores and multiprocessors, heisenbugs have started to occur more frequently, instruction set simulators help in this regard as well. You will always get the same output no matter how many times you re-execute the program in a multi-core or multiprocessor. Therefore complete control of the system to track changes at instruction level can provide comprehensive insight about the behavior of the applications which may be used to address issues spanning all areas of multi-cores(mainly three), that is, compiler, architecture and application.

Aim of ISS (Instruction set simulators)
Instruction set simulator is used to check functional correctness of the application and bring the code to life. Since they are not intended to get actual real data/values therefore a lot of tricks and workarounds are done to simulate the actual behavior of the system. These shortcuts lower the simulation workload enormously that’s why they are very fast as compared to cycle accurate simulators. Even these are capable of simulating multiprocessors systems at satisfactory speed and accuracy.
One such simulator is Simics, which is a System-level Instruction Set Simulator.
4.2 Introduction to Simics

Simics is a virtualized software development platform developed by Virtutech® [6]. It provides the hardware and software developers with the virtual version of their target hardware and is capable of running from a single CPU with local memories to a complex system on chip (SOC) at good speeds. At the same time debugging and testing is simplified with the help of check points, determinism and reverse execution.

4.2.1 VSD (Virtualized software development)

Background

Moore’s law still holds, now in form of multi-cores, therefore with increase of the transistors complexity of the electronics systems is increasing every day. Also if we take the example of mobile phones, now a day the other factor increasing the complexity of the system is that devices communicate with their environment frequently. For example a mobile phone device through Bluetooth™ and Wi-Fi™ interacts with its surroundings.

These two trends have in turn made the software increasingly complex. Now considering these obstacles if the target hardware is in short supply or it does not exist then it’s a nightmare for software developers. One option is to test software on something that some what at least approximates the production hardware. In the wake of an evolving application and the hardware that does not exist both these approaches are un-reliable thus not practical.

Solution VSD (Virtualized Software Development)

Simics jumps in here with its so called VSD solution (see Figure 7) that combines the speed and accuracy of software development to the desktop PC. Virtualized software development is a way of developing software with out the need of actual target hardware, on which the software will eventually run. VSD allows the software developers to use target hardware on their own workstations.

Since VSD allows running the exact same binary that would run on physical hardware therefore it eliminates the need to use stubbed software or API abstraction layers for two different environments e.g. production environment and test lab environment.

To accomplish above mentioned goals VSD takes care of following four areas

1. Provides an instruction set simulator for the microprocessors in the target hardware
2. Provides device models (simulating the behavior of devices) in the target hardware that the software might interact with
3. Takes care of interaction, if any, among multiple simulated targets or outside world(e.g. networks, firewall etc)
4. Allows the software developer to use all the tools that he might use with actual physical target

Electronic design automation (EDA) industry also provides simulation tools for software development which are very accurate as well but they take enormous time to execute the software. VSD is valuable in this regard as well since it gives real time simulation speed.
4.3 Simics - software development concepts

Simics is a system level instruction set simulator which means that

- Simics can model the target system at instruction level (executing them one by one) and
- Simics interface for application binaries to the virtual hardware model is so accurate that it can execute the same binaries that run on real hardware.

This essentially means that Simics is capable of running and debugging almost any kind of software, firmware, hardware drivers and operating systems.

4.3.1 Simulation limits

However one should take care of a few things while developing software in Simics. The model of time in Simics is pretty trivial; it assumes that all the instructions take same amount of time to execute. There might be some issues in multiprocessor environments where certain assumptions are made about delayed inputs or outputs, however this is not an issue majority of the times. Also the model of the target hardware should be detailed enough so that while running, software should not detect any difference between real and virtual hardware.

4.3.2 Simics debugging capabilities

For any software application, speedy development and quick time to market is directly proportional to the debugging capabilities of its development environment.

*Simulation time and debugging*

One of the biggest advantages of full system simulation is that time in the simulation is completely independent of the real world time. This gives a number of advantages for example

- One can pause and view the state of system at any point which is almost impossible in real hardware
- State of the system can be saved into disk (checkpoint) and may be restored later
- No heisenbugs, complete determinism
- Reverse execution, very handy to find elusive bugs

*Debugging*

The most powerful tools for debugging in Simics include

1. Breakpoint support
2. Scriptable debug and symbol information handling

**Breakpoints**
Breakpoint in Simics can be set on code as well as data e.g. they can be set on memory accesses, time, instruction types, device accesses and output on the console.

**Symbolic Debugging**
The breakpoints set at bits and bytes level are not always meaningful and required. Debugger should enable the user to think at higher level as well i.e. in terms of functions, processes and named variables.
Simics implements this using certain classes namely context, symtable and process trackers.

These concepts are critical in order to simulate multi-cores in Simics.

**Context**
A context object symbolizes a virtual address space which is assigned to a processor in multi-core simulation. If the context is selected for a processor, this address space is visible to the code running on the processor. Similarly virtual breakpoints can be assigned to a virtual address space. In a multi-core environment, context objects are very useful for debugging and measurements e.g. during simulation if you want to inspect code running on a certain processor, you can select that processor using “pselect” and set breakpoint in its context. So it allows you to maintain separate debugging symbols and breakpoints for separate processors in the target machine.
However context object does not in any way effect correctness of simulation, they are just used to understand the software.

**Symtable**
Symtable objects are used to store information about symbols and debugging for a certain virtual address space. Symtables are associated with context objects and are used by Simics to switch between code addresses, variable names and memory locations.

**Symbolic Breakpoints**
In this thesis work symbolic breakpoints along with haps are extensively used to extract profiling data from simulation and thereby used for performance measurements.
Following statement tells how to read symbolic information from a binary file.

```
new-symtable st0 file = my_file
```

Here symbolic information is read from binary file “my_file” and stored in a new symtable named “st0”.
5 Modeling in Simics

This section starts with a brief description of the modeling process in Simics. After that it explains how different components of system are modeled in Simics. Finally it elaborates how to setup different machine configurations using scripts and how starting from a single core DSK6455 board I created its 14 core model.

5.1 Simics Modeling Process

For developing a virtual system in Simics, there is a generic out line

- Create list of devices, processors etc that constitute the system
- Decide level of abstraction according to requirements
- Reuse if device models already exist, use the device modeling language(DML) to create the remaining devices
- Test the newly created system with the intended software and iteratively compensate and improve the model to desired levels

The key in development is to get the working prototype early no matter how trivial it is and iteratively enhance its functionality.

5.2 Simics Timing concepts

Simics simulates the behavior of the system and does not implement actual physical phenomena. Simics simulation model does not model the actual details of how bits or bytes are transferred across interconnect, instead it can be considered as one possible implementation of the target architecture. For example, in a real physical system, a processor requests bus access in order to write to a memory location but in Simics reads and writes are directly routed to target memories without involving any buses. To make the virtual target work like the physical one, Simics employs certain proprietary tricks and techniques.

5.2.1 Timing Model

One of the major differences that can exist between real hardware and Simics simulation model is timing. This difference could be due to number of reasons e.g. incomplete documentation, desire to increase simulation speed etc. The most significant timing difference between real and Simics model is observed in instruction execution timings. For example in real hardware instruction timing depends upon memory access latencies, bus contention etc whereas in Simics, by default, each instruction takes exactly one cycle to finish. However in order to simulate actual behavior, it is possible to build timing accurate models and connect them to Simics.

In Simics, completion of one simulation instruction is also called execution of one step.

Instruction Execution Timings

In-order mode
In default mode, Simics executes one instruction in one cycle. It does not model actual execution timing in any way. So in this case number of cycles equals the number of instructions.

Stalling mode
If the goal of simulation is to perform detailed studies, e.g. involving timing of memory access operations, then Simics functionality of in-order model may be enhanced by adding so
called *timing models*. This is usually done using *memory hierarchy interface* (see section 5.3.2). In this mode of simulation, instructions no longer finish atomically but rather stall for a specified number of cycle events before a step event is executed.

### 5.3 Simics System Modeling Breakdown

Simics divides the system into three broad categories and models them differently

1. Device modeling
2. Memory system modeling
3. Processor modeling

#### 5.3.1 Device modeling

Device modeling in Simics is implemented using a technique called transaction level modeling (TLM) which uses Virtutech’s device modeling language (DML) [13]. When a device is presented with a request it computes the results and replies. As explained above, it does not bother about bits and bytes, making implementation convenient as well as efficient.

#### 5.3.2 Memory system modeling

Simics has developed a very efficient technique to handle the memory system and processor bus interface. This technique is instrumental in Simics success of ensuring a very fast simulation. Processor address space is modeled as a memory map and the target memories and devices in the system are assigned to that memory space (see Figure 8). So reads and writes are routed directly to the recipient devices with out involving any buses or bridges.

If system timing requirements are not affected by impact of cache hierarchies and bus access latencies, then this method often allows the virtual system to perform better, in terms of speed, than the original system. Please see section 5.2 for timing details.

#### Memory Spaces

Memory accesses in Simics are handled by the generic *memory-space* class. An object of class memory-space implements necessary functions for memory accesses and has attributes specifying how memory mappings are setup for a processor. The most important attribute in memory-space class is the *map* attribute which provides a list of mapped objects in a given memory-space. Those could include devices, RAM, ROM or even other memory-spaces.

The following example from DSK6455 Simics model explains the concept of memory-spaces and their usage.

For example first statement below creates a memory space object called “phys_mem” and the 2nd statement maps a RAM object (namely iram) into this memory space object.

```plaintext
self.o.phys_mem = pre_obj('phys_mem', 'memory-space')
self.o.phys_mem.map = [0x00000000, self.o.iram, 0, 0, 0x10000000]
```

In the following statements, a CPU object is created and this memory-space (phys_mem) is assigned to it. So now the CPU object (namely cpu) can access this memory (iram) at address 0x00000000.

```plaintext
self.o.cpu = pre_obj('cpu', 'tms320c64plus' + classname_suffix_cpu)
self.o.cpu.physical_memory = self.o.phys_mem
```
**Memory transactions**
In Simics, both devices and CPUs can initiate memory transactions. ACPU can get the physical address (from virtual address) after it is translated by MMU whereas device transaction does not require any translation. The physical address is actually mapped to a device or memory (RAM, ROM etc) by memory-space and an access to the physical address is automatically sent to the right target by the memory-space class. For observing or modifying memory transactions, memory-space class has a special memory hierarchy interface. This interface in fact consists of timing_model interface (gives access to transaction before execution) and snoop_memory interface (provides transaction access after it has been executed).

---

**Figure 8:** Simics model of the newly created 14 core DSK6455 DSP board

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**5.3.3 Processor Modeling**
In Simics processor modeling is not done using DML because then simulation of processor alone would consume all the processing power of the host machine. The processor models are developed and shipped by Virtutech® and are highly optimized, enabling Simics to simulate billions of instructions per second.

---

**5.4 Modeling of 14 Core DSK6455 DSP Board**
This section explains how different elements of Simics are put together to create a working virtual model of a target physical system. At the same time DSK6455 model is related to these details where possible. Simics model is designed in bottom-up fashion, first of all devices are created which are combined to form components. Finally a complete system is constructed in Simics, using configuration scripts (see Figure 9).
5.4.1 Components
Any standalone piece of hardware that can be connected or removed from the system is represented by a component in Simics. A component is basically a collection of devices which are connected together though different interfaces. Components have various types of standard connectors in order to connect to interfaces like Ethernet and buses. Components hide complexity of the system and give an easy to understand overview of the system from outside. It is implemented by a component module which is placed in the workspace directory. Components are written in “python™” DSK6455 component is named “dsk6455_components.py”.

5.4.2 Configurations and Scripts
Most convenient way of starting Simics is through configurations using scripts. Configurations actually define different components and objects and tell how they are interconnected. So scripts can be considered at a higher level of abstraction, above components.

5.4.3 System Setup
To setup machines and systems in Simics, a configuration consists of many scripts. However for each configuration there should be at least three kind of scripts.

- **<machine>-common.simics**
  This script actually defines the complete simulated machine. This script file uses “–system.include” to define hardware and “–setup.include” to define the software of the system. However since DSK6455 is an embedded system and there is no operating system present therefore our configuration does not have any “–setup.include” script file. So “-common.simics” script incorporates this functionality as well.

  In our configuration “-common.simics” script is named “himalaya-selftest.Simics”.

- **<architecture-variant>-system.include**

  This script defines the hardware of the system.
  In our case this script is called “himalaya-system.include”.

- **<machine>-setup.include**
It defines the software for the system. In our case this script is part of the common.simics script.

5.4.4 Path to 14 core Model- Technical details
Initially the aim of this work was to create a 16 core model however the LTE application dictated that a 14 core model will be the optimal one (will be explained in section 5). Since no new devices were required in order to scale the model from single core to 14 cores therefore I conveniently skipped to the last part of Simics model development process. I used the existing devices and modified the Simics model at component level.

4 Core Model
The given LTE application consists of 4 major parts therefore the obvious first step, towards a 14 core DSK6455 DSP, was to first create a 4 core model. This model not only provides a standalone DSP solution, running all parts of LTE application on a single board, but also serves as a guideline for creating the 14 core model. The process of creating 4 core and 14 core model in Simics is exactly the same. So in Simics one may create as many cores as one likes, as long as the software can handle it.

The given single core Simics model consisted of a single component (dsk6455) which represents a Texas Instruments DSK6455 board. This board has one (C64x+) CPU core. I modified this piece of hardware (represented by dsk6455 component class in Simics) and added 3 more CPU objects in it. For each CPU a separate memory-space object is created and all the devices on board are mapped into it. Please see section 5.3.2 for an example.

All the CPUs in the new 4 core DSK6455 model share the same address space on board (see Figure 10). All I/O devices and memories are shared among all CPUs. However for smooth functioning of this multi-core model, synchronization and mutual exclusion is maintained through the application software. For mutual exclusion semaphores are used which make sure that different CPUs do not step on each other’s feet. The application programs assigned to each CPU core are loaded into a pre-allocated area in the internal on chip memory (namely iram). This particular memory section is local to every CPU core and no other processor can access it. The rest of the iram is shared and is available to every CPU, so it may be called as the working area for all (4 or 14) cores on board. Here with the help of synchronization primitives, output from one CPU core may be used by the other one as input. For example “Antenna_Combine” part of the LTE application uses the result from “Channel_Estimates” part as input operating in the same shared memory.
14 core model
The construction of the 14 core model in Simics is the same story as 4 core model. Here I created 14 CPU objects instead of 4, as in previous case and repeated all the steps mentioned in section 5.4.4 (see Figure 8).

Therefore creation of a multi-core model in Simics is relatively trivial; the real challenge is to build a complete working software hardware package that optimally utilizes the full potential of all cores. For that matter comprehensive understanding of the given software application is required.
6 Application Case Study

This section starts with a brief introduction to LTE uplink processing. It then explains 4 part functional division of the LTE uplink processing application. Next it explains how 4 part application is further divided into 14 functionally independent parts that can be processed autonomously. In the last part, issues and avenues related to future scalability of this model e.g. increasing the number of cores, limitations and bottle necks are discussed.

6.1 LTE Uplink Processing

For both uplink and downlink LTE uses OFDM as the radio technology. However, to compensate for high peak to average power ratio (PAPR) of OFDM, uplink uses a special pre-coded version of it, called SC-FDMA. In order to understand LTE uplink processing first hand knowledge of the uplink physical layer is required.

6.1.1 LTE Uplink resource grid

In the time domain, one uplink slot is 0.5ms in length and contains 7 OFDM symbols (see Figure 11). In frequency domain, subcarrier spacing is 15 kHz. 12 subcarriers combine to make a resource block (see Figure 11). Each resource block has 84 resource elements. One resource element may contain different number of bits based on the modulation scheme. For example for 64QAM each resource element will contain 6 bits. Similarly for 16 QAM modulation scheme one resource element will contain 4 bits. Bit rate or bandwidth for a certain user is directly proportional to the modulation scheme used for the resource elements, the higher the modulation scheme the more the bandwidth.

6.1.2 Data Flow

Figure 12 shows simplified block diagram for LTE uplink processing application. Every 70 microseconds antennas generate data and a new symbol (1200 complex data) arrives. As described earlier, 7 consecutive symbols are grouped together to form one uplink slot. Data is processed one slot at a time. Since new data is coming all the time therefore LTE application is required to process an uplink slot before a new one has arrived or in other words, LTE application has to finish processing(one uplink slot per user) within 0.5 milliseconds barrier (7 symbols × 70µs ≈ 0.5 ms).
Out of seven symbols in a slot, fourth symbol is called the reference symbol. This symbol is used to calculate channel estimates. Channel estimates are required to process the remaining symbols (6) in the corresponding uplink time slot. This step is identified as “Antenna Combine” and its output is user symbols which are used in next stage. Finally in the end, based on the modulation scheme and constellations, values are normalized and demapped to generate 8 bit soft values.

### 6.2 LTE application - functional division for 4 core model

LTE uplink processing may be divided into 4 major stages (see Figure 13). Therefore based on this functional division, the given LTE application software has four main parts namely

1. Antenna data Generation (stage 1)
2. Channel estimation (stage 2)
3. Antenna Combine (stage 3)
4. Scale and Demap (stage 4)

Please note these are not the standard names; they simply identify and give understanding of each stage

#### 6.2.1 Antenna Data Generation

In a real setup, this part will not be required since physical antennas will serve this purpose. However as we are working in a simulated environment therefore we need a data source that is generating antenna data all the time (see Figure 13).

It is assumed that there are two antenna data sources. This part of application basically generates dummy antenna data and fills the data buffers allocated for incoming data symbols. One OFDM symbol is generated in every iteration of this program. According to LTE specifications, a physical antenna generates a new symbol every 70μseconds therefore in this simulated setting, calibrations are done with the help of special loops such that a new symbol
is generated every 70 microseconds. Since each time slot consists of 7 symbols therefore the buffer values are overwritten after every “0.5 milliseconds (70µs × 7 ≈ 0.5ms).

6.2.2 Channel Estimation
This part of the application waits for the reference symbol (4th) in every slot. Once the reference symbol is available from both the antennas, it starts to calculate the channel estimates.
When finished it writes the estimates in the shared memory and stops processing until reference symbol for the next uplink slot is available. At the same time it triggers next part of the application to go ahead, see stage 2 in Figure 13

6.2.3 Antenna Combine
In this stage of uplink processing data symbols are available even when channel estimation is being done but it has to wait for the results from 2nd stage in order to process them. Once channel estimates are available it processes the symbols one by one and generates user symbols which are used in the next stage to get soft values. When finished it triggers the final stage.

6.2.4 Scale and Demap
This is the final stage in uplink processing. It waits for the user symbols from the “Antenna Combine” stage and converts them to soft 8 bit values which are understandable by computers.

6.3 LTE application – functional division for 14 Core model
The functional division of LTE application into 4 parts was pretty straightforward. Next step was to further divide the application into parts that may be processed independently, so that the processing power of the envisioned 16 core DSK6455 DSP, which eventually reduced to 14 cores (see Figure 15), is fully utilized.

6.3.1 Parallelization process
For the sake of parallelizing, I deliberated on last three stages of LTE uplink processing (since first stage in this model is just meant for simulating antenna behavior).

Parallelism in “Channel Estimate” stage
This part of the application basically processes the 4th symbol or the reference symbol (see Figure 13) in the uplink slot. A good look at the code reveals that, at macro level, there are no functionally independent sections. Mainly there are loop carried dependencies therefore to extract functionally independent parts of this code sophisticated code optimization techniques like loop unfolding [9], software pipelining [10], DO-ACROSS parallelism [11] and Sensitivity analysis) [12] may be used.
Parallelism in “Antenna Combine” stage
Antenna combine stage processes the remaining 6 symbols in the uplink slot (excluding the reference symbol). Each of these symbols is processed independently of each other, one by one. Since there is no functional dependence among these symbols therefore every symbol may be processed independently of each other. So instead of processing each symbol one by one, all of them may be processed in parallel at once. This functional division can straight away reduce the processing time for this part of the application by a factor of 6. That is exactly what I have done (see Figure 14).

Parallelism in “Scale and Demap” stage
This is the final part of the application and its functionality is pretty similar to the previous “Antenna Combine” stage. It also processes 6 symbols in the corresponding uplink slot, one by one, generating soft values for each of them. Since there are no dependencies among these symbols therefore these symbols can be processed in parallel and latency for this stage can be reduced 6 times as well (see Figure 14).

6.3.2 Putting it all together
After the functional division of last two stages of the LTE application into 6 parts each, now we have identified 14 functionally independent parts of that application that may be processed in parallel. So if we use the originally planned 16 core model of DSK6455 DSP, 2 cores of the chip will be literally sitting idle doing nothing therefore a decision was made to use a 14 core model instead of 16 cores.

6.3.3 Future Applicability of this method
The method used in dividing this application into 14 independent parts may be extended by having detailed studies of the actual complete version of the LTE application and by looking at LTE physical layer specifications in depth.
Using this 14 core application model, one straight forward enhancement could be to a 28 core hardware model. By introducing a secondary antenna data source on chip, operating at frequencies other than the previous sources to avoid interference, to feed the newly added 14 cores, if dynamic load sharing can be done, this form of parallelism can reduce hardware and power costs.
Figure 16: LTE uplink processing 14 core model
7 Experimental Results

The main aim of this thesis work is to study and comprehend the potential of Virtualized System Development and to use Instructions Set Simulation for creating hardware that does not exist and then test an application on it that is still evolving. Also LTE application used for this thesis work does not represent the actual work load therefore it is meaningless to look for numbers as they can not be compared with actual existing commercial DSPs in real working environment. Also Instruction Set Simulators make use of certain tricks to simulate the actual behavior of the physical target hardware therefore it can not be relied upon for precise calculations.

However in this thesis work, two multi-core models are discussed, 4 cores and 14 cores. The four core model was built to port all parts (4) of the LTE application on a single board to make it a stand alone DSP solution. Therefore it is used as a reference point in relation to further enhancement towards the 14 cores model.

In the rest of this section I will briefly explain the experimental setup used for the calculations and results related to different parts of the LTE application and overall performance enhancements from 4 cores to 14 cores model.

7.1 Statistics for the LTE Application

7.1.1 Experimental Setup

CPU Frequency = 1000 MHz

For all the calculations, the codes are compiled in the “Code Composer Studio” at optimization level zero (0) except “Antenna Generation” part where optimization level 2 is used.

Antenna Data generation setup
Since we need to simulate antenna data to generate a symbol every 70µs therefore operating at 1000 MHz, every 70000 intervals a new symbol is generated (Simics assumes a perfect memory model and executes an instruction every new cycle therefore cycle rate =step rate here).

7.1.2 Results
This part gives details about statistical numbers (number of cycles consumed) in a particular section of code. Since 0.5millisecond is the time barrier to complete the uplink processing for one time slot therefore I have chosen it as the reference point for all calculations. Firstly time for every individual stage of application is calculated then a comparison is made, for complete application time, between 4 and 14 cores to see if it meets the 0.5millisecond barrier.

Time is calculated in terms of number of cycles (as CPU frequency is 1000MHz therefore 1000 cycles equal one microsecond).

Individual stages
Table 2 summarizes the speedup for different stages in the application. Stages “Antenna Combine” and “Scale and Demap” are divided into 6 parts each whereas “Channel Estimate” stage remains unchanged.
Table 2: Speedup comparison between Parallel and Sequential execution

<table>
<thead>
<tr>
<th>Application Stage</th>
<th>Sequential (Single-core)</th>
<th>Parallel (6 cores)</th>
</tr>
</thead>
<tbody>
<tr>
<td></td>
<td>Cycles consumed</td>
<td>Time consumed (milliseconds)</td>
</tr>
<tr>
<td>Channel Estimate</td>
<td>110227</td>
<td>0.110</td>
</tr>
<tr>
<td>Antenna Combine</td>
<td>916135</td>
<td>0.916</td>
</tr>
<tr>
<td>Scale and Demap</td>
<td>292781</td>
<td>0.292</td>
</tr>
</tbody>
</table>

Figure 17: Antenna Combine, parallel vs. serial execution

Figure 18: Scale and Demap, parallel vs. serial execution
**Complete application time**

After antenna data is generated, Table 3 shows total time consumed to process one uplink slot (time consumed by all 3 parts of the application, starting from Channel_Estimate through Antenna_Combine till Scale_Demap).

*Uplink processing for the very first time slot consumes 1.38 milliseconds, after that when data is in pipeline, processing for one uplink slot, on the average, takes 0.902 milliseconds.*

<table>
<thead>
<tr>
<th></th>
<th>Execution Time</th>
</tr>
</thead>
<tbody>
<tr>
<td></td>
<td>Cycles consumed</td>
</tr>
<tr>
<td><strong>4 Cores</strong></td>
<td>901970</td>
</tr>
<tr>
<td><strong>14 Cores</strong></td>
<td>410942</td>
</tr>
</tbody>
</table>

**7.1.3 Discussion**

From hypothetical point of view and for the sake of comparison, in case of 4 core model the results reveal that if the data is processed in a sequential manner, this implementation of the application processes one uplink slot in **0.902 milliseconds** which breaks the **0.5 milliseconds** barrier. Parallelizing the second and third stage of the application straight away gives an improvement by a factor of 6 in those stages however 14 cores model completes the
processing in **0.410 milliseconds** which meets the time limit but does not reflect a linear speed up in relation to the amount of hardware added (10 new cores) or the speed up in the 3\textsuperscript{rd} and 4\textsuperscript{th} stage (under ideal conditions time consumed for all three stages should be around **0.311 milliseconds**).

This is because new data from antenna source (stage 1 is the bottleneck) is not available for processing while the later stages (3 and 4) have finished their processing of previous uplink slot. Actually antenna source is generating the data every 70 microseconds and measurements reveal that “Antenna Combine” (3\textsuperscript{rd} stage) has to wait for the antenna data, on the average, for 33 microseconds even when the channel estimates are available. This is almost one half of the time to generate one uplink symbol. This time may be used to serve another antenna source.
8 Conclusion

Foremost conclusion of this thesis work is that “Virtualized System Development”, employing “Instruction Set Simulation” technique, accelerates the application development time because target hardware is available even before it physically exists. This allows the software development team to begin process of experimentation and development right away and an early start in development eventually exposes the design flaws in both hardware and software much earlier in the development cycle of the actual physical product. One example is how the architecture of LTE application influenced to reduce the originally planned 16 cores model to 14 cores.

Also VSD enables the development team to focus on their actual goals i.e. a developer consumes almost 60% of the time in debugging and finding errors in code and these matters have been even complicated with the introduction of “heisenbugs” in case of multi-cores. Now because of deterministic reproducible execution and excellent debugging capabilities, VSD can reduce this time many folds allowing the developer to spend more time on development rather than debugging.

Simics as a simulation tool is pretty fast and accurate capable of scaling to hundreds of multiprocessors and multi-cores (using technologies like JIT, page sharing and multi-threading). With very good debugging and testing capabilities (deterministic execution, inject faults seamlessly using scripts, reverse execution, ability to save system state and replay it) which are critical for multi-core software development in the wake of heisenbugs.

The interaction with the LTE application reveals that there is lot of parallelism available in it which is evident from the results obtained from the 14 core model. Over all system latency is reduced almost three fold as compared to 4 core model. The same is true for all signal processing applications. In essence, using virtualized system development, detailed studies of the LTE application promises to reveal number of avenues leading to a rapid cost effective multi-core solution that spans dozens of cores.
9 Future Work

The success of a “multi-core solution” lies in its ability to divide and do work in parallel. The 14 core model, created during this study, actually represents one way of dividing the uplink processing into 14 parts. Therefore to further increase the throughput (number of users) one way is to reduce the latency by further dividing the LTE uplink processing into independent parts, let’s say 30, and subsequently develop a 30 cores model for it. This requires advanced and in depth studies focusing on all layers (e.g. PHY, MAC, RLC etc) of the LTE protocol. In this case, a reduction in latency would mean that more users can share, thus be accommodated, in a given time slot (since every user needs to be scheduled only after every 0.5 milliseconds).

![Time shared uplink slot](image)

Another important aspect is that in LTE a lot of intelligent decision making is delegated to the base station. For example unlike HSPA, in LTE data rate of the terminal (user) is controlled by NodeB (base station). Also LTE schedules the users based on channel conditions (shared channel assignment and data rate). Therefore if two users are sharing a channel in time and frequency domain, one with high data requirements (real time video content) and the other one with minimal services (just updating it’s live status) then for optimal resource utilization future base stations would require intelligent Linux® like operating systems, capable of efficiently utilizing the available resources (using task sharing and load management) by temporarily taking resources from one user and allocating them to the demanding one.

Now to explore all these possibilities, involving the software and hardware that does not exist, virtualized software development (Instruction Set Simulation) seems to be the only solution.
10 References


[3] LTE (Long Term Evolution), first 4G wireless communication systems


[14] “Modeling your system in Simics” v.4
